Quad single-pole single-throw analog switch

Rev. 7 — 2 April 2013

Product data sheet

1. General description

The 74HC4066; 74HCT4066 is a quad single pole, single throw analog switch. Each switch features two input/output terminals (nY and nZ) and an active HIGH enable input (nE). When nE is LOW, the analog switch is turned off. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

2. Features and benefits

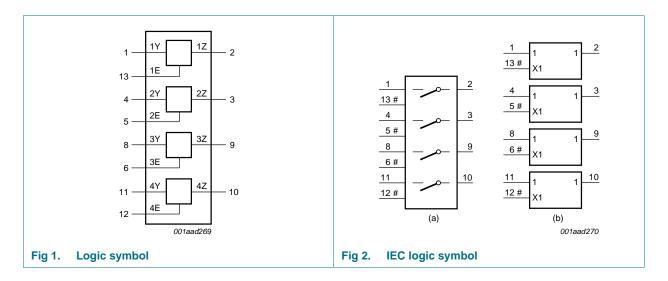
- Input levels nE inputs:
 - For 74HC4066: CMOS level
 - ◆ For 74HCT4066: TTL level
- Low ON resistance:
 - 50 Ω (typical) at V_{CC} = 4.5 V
 - 45 Ω (typical) at V_{CC} = 6.0 V
 - 35 Ω (typical) at V_{CC} = 9.0 V
- Specified in compliance with JEDEC standard no. 7A
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



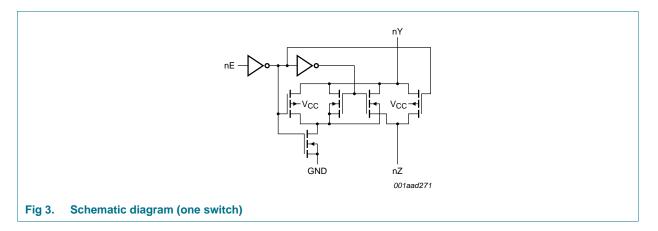
3. Ordering information

Table 1. Orde	ering information				
Type number	Package				
	Temperature range	Name	Description	Version	
74HC4066N	–40 °C to +125 °C	C to +125 °C DIP14 plastic dual in-line package; 14 lea		SOT27-1	
74HCT4066N					
74HC4066D	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width	SOT108-1	
74HCT4066D			3.9 mm		
74HC4066DB	–40 °C to +125 °C	SSOP14	plastic shrink small outline package; 14 leads; body width 5.3 mm	SOT337-1	
74HCT4066DB					
74HC4066PW	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body	SOT402-1	
74HCT4066PW			width 4.4 mm		
74HC4066BQ	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very	SOT762-1	
74HCT4066BQ			thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm		

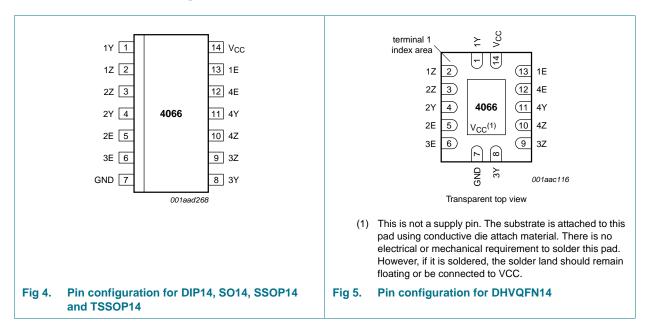
4. Functional diagram



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5. Pinning information



5.1 Pinning



Symbol	Pin	Description
1Z, 2Z, 3Z, 4Z	2, 3, 9, 10	independent input or output
1Y, 2Y, 3Y, 4Y	1, 4, 8, 11	independent input or output
GND	7	ground (0 V)
1E, 2E, 3E, 4E	13, 5, 6, 12	enable input (active HIGH)
V _{CC}	14	supply voltage

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6. Functional description

Table 3.	Function table ^[1]	
Input nE		Switch
L		OFF
Н		ON

[1] H = HIGH voltage level;

L = LOW voltage level.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+11.0	V
I _{IK}	input clamping current	$V_{\rm I}$ < –0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V	-	±20	mA
I _{SK}	switch clamping current	V_{SW} < –0.5 V or V_{SW} > V_{CC} + 0.5 V	-	±20	mA
I _{SW}	switch current	V_{SW} = –0.5 V to V_{CC} + 0.5 V	<u>[1]</u> _	±25	mA
I _{CC}	supply current		-	50	mA
I _{GND}	ground current		-	-50	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	[2]		
		DIP14 package		-	750
		SO14, (T)SSOP14 and DHVQFN14 packages		-	500
Р	power dissipation	per switch	-	100	mW

[1] To avoid drawing V_{CC} current out of terminal Z, when switch current flows in terminals Yn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no V_{CC} current will flow out of terminals Yn. In this case there is no limit for the voltage drop across the switch, but the voltages at Yn and Z may not exceed V_{CC} or GND.

For DIP14 package: P_{tot} derates linearly with 12 mW/K above 70 °C.
 For SO14 package: P_{tot} derates linearly with 8 mW/K above 70 °C.
 For (T)SSOP14 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C.
 For DHVQFN14 packages: P_{tot} derates linearly with 4.5 mW/K above 60 °C.

Recommended operating conditions 8.

Table 5. Recommended	l operating conditions
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Symbol	Parameter	Conditions	74HC4066			74HCT4066			Unit
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	10.0	4.5	5.0	5.5	V
VI	input voltage		GND	-	V_{CC}	GND	-	V_{CC}	V
V _{SW}	switch voltage		GND	-	V_{CC}	GND	-	V_{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V
		$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V
		V _{CC} = 10.0 V	-	-	35	-	-	-	ns/V

Static characteristics 9.

R_{ON} resistance per switch for types 74HC4066 and 74HCT4066 Table 6.

 $V_I = V_{IH}$ or V_{IL} ; for test circuit see <u>Figure 6</u>.

 V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input.

 V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

For 74HC4066: V_{CC} – GND = 2.0 V, 4.5 V, 6.0 V and 9.0 V. For 74HCT4066: V_{CC} – GND = 4.5 V.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	–40 °C to	Unit	
				Min	Typ <mark>[1]</mark>	Max	Min	Max	1
R _{ON(peak)}	ON resistance (peak)	$V_{is} = V_{CC}$ to GND							
		$V_{CC} = 2.0 \text{ V}; \text{ I}_{SW} = 100 \mu\text{A}$	2]	-	-	-	-	-	Ω
		V_{CC} = 4.5 V; I_{SW} = 1000 μ A		-	54	-	118	142	Ω
		V_{CC} = 6.0 V; I_{SW} = 1000 μ A		-	42	-	105	126	Ω
	$V_{CC} = 9.0 \text{ V}; I_{SW} = 1000 \mu\text{A}$ - 32	-	88	105	Ω				
R _{ON(rail)}	ON resistance (rail)	V _{is} = GND							
		$V_{CC} = 2.0 \text{ V}; \text{ I}_{SW} = 100 \mu\text{A}$	2]	-	80	-	-	-	Ω
		V_{CC} = 4.5 V; I_{SW} = 1000 μ A		-	35	-	95	115	Ω
		V_{CC} = 6.0 V; I_{SW} = 1000 μ A		-	27	-	82	100	Ω
		V_{CC} = 9.0 V; I_{SW} = 1000 μ A		-	20	-	70	85	Ω
		$V_{is} = V_{CC}$							
		$V_{CC} = 2.0 \text{ V}; \text{ I}_{SW} = 100 \mu\text{A}$	2]	-	100	-	-	-	Ω
		V_{CC} = 4.5 V; I_{SW} = 1000 μ A		-	42	-	106	128	Ω
		V_{CC} = 6.0 V; I_{SW} = 1000 μ A		-	35	-	94	113	Ω
		V_{CC} = 9.0 V; I_{SW} = 1000 μ A		-	20	-	78	95	Ω

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Table 6. R_{ON} resistance per switch for types 74HC4066 and 74HCT4066 ...continued

 $V_I = V_{IH}$ or V_{IL} ; for test circuit see Figure 6.

 V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input. V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output. For 74HC4066: $V_{CC} - GND = 2.0 V$, 4.5 V, 6.0 V and 9.0 V.

For 74HCT4066: $V_{CC} - GND = 4.5 V.$

Symbol	Parameter	Conditions		–40 °C to +85 °C			–40 °C to	Unit	
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
ΔR _{ON}	ON resistance mismatch between channels	$V_{is} = V_{CC}$ to GND							
		$V_{CC} = 2.0 V$	[2]	-	-	-	-	-	Ω
	Charmers	$V_{CC} = 4.5 V$		-	5	-	-	-	Ω
		$V_{CC} = 6.0 V$		-	4	-	-	-	Ω
		$V_{CC} = 9.0 V$		-	3	-	-	-	Ω

[1] Typical values are measured at $T_{amb} = 25 \ ^{\circ}C$.

[2] At supply voltages (V_{CC} – GND) approaching 2 V, the analog switch ON resistance becomes extremely non-linear. Therefore it is recommended that these devices be used to transmit digital signals only, when using these supply voltages.

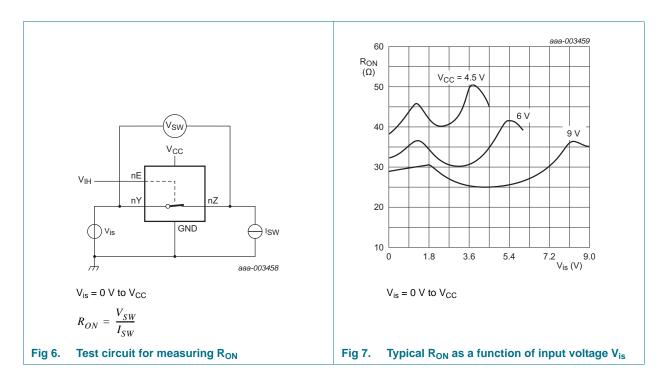


Table 7. Static characteristics 74HC4066

At recommended operating conditions; voltages are referenced to GND (ground = 0 V). V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input. V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
$\Gamma_{amb} = -40$	0 °C to +85 °C					
V _{IH}	HIGH-level input voltage	$V_{CC} = 2.0 V$	1.5	1.2	-	V
		$V_{CC} = 4.5 V$	3.15	2.4	-	V
		$V_{CC} = 6.0 V$	4.2	3.2	-	V
		$V_{CC} = 9.0 V$	6.3	4.7	-	V
/ _{IL}	LOW-level input voltage	$V_{CC} = 2.0 V$	-	0.8	0.5	V
		$V_{CC} = 4.5 V$	-	2.1	1.35	V
		$V_{CC} = 6.0 V$	-	2.8	1.80	V
		$V_{CC} = 9.0 V$	-	4.3	2.70	V
I	input leakage current	$V_{I} = V_{CC}$ or GND				
		$V_{CC} = 6.0 V$	-	-	±1.0	μΑ
		V _{CC} = 10.0 V	-	-	±2.0	μA
S(OFF)	OFF-state leakage current	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$				
		per channel	-	-	±1.0	μA
S(ON)	ON-state leakage current		-	-	±1.0	μΑ
сс	supply current					
		$V_{CC} = 6.0 V$	-	-	20.0	μA
		V _{CC} = 10.0 V	-	-	40.0	μA
Ci	input capacitance		-	3.5	-	pF
C _{sw}	switch capacitance		-	8	-	pF
$\Gamma_{amb} = -40$	0 °C to +125 °C					
/ _{IH}	HIGH-level input voltage	$V_{CC} = 2.0 V$	1.5	-	-	V
		$V_{CC} = 4.5 V$	3.15	-	-	V
		$V_{CC} = 6.0 V$	4.2	-	-	V
		$V_{CC} = 9.0 V$	6.3	-	-	V
/ _{IL}	LOW-level input voltage	$V_{CC} = 2.0 V$	-	-	0.50	V
		$V_{CC} = 4.5 V$	-	-	1.35	V
		$V_{CC} = 6.0 V$	-	-	1.80	V
		V _{CC} = 9.0 V	-	-	2.70	V
I	input leakage current	$V_{I} = V_{CC}$ or GND				
		$V_{CC} = 6.0 V$	-	-	±1.0	μA
		V _{CC} = 10.0 V	-	-	±2.0	μA
S(OFF)	OFF-state leakage current	$V_{CC} = 10.0 \text{ V}; \text{ V}_{I} = \text{V}_{IH} \text{ or } \text{V}_{IL};$ $ \text{V}_{SW} = \text{V}_{CC} - \text{GND}; \text{ see } \frac{\text{Figure 8}}{\text{Figure 8}}$				
		per channel	-	-	±1.0	μA
S(ON)	ON-state leakage current	$V_{CC} = 10.0 \text{ V}; \text{ V}_{I} = V_{IH} \text{ or } \text{V}_{IL};$ $ V_{SW} = V_{CC} - \text{GND}; \text{ see } \frac{\text{Figure 9}}{\text{Figure 9}}$	-	-	±1.0	μA
		information provided in this document is subject to legal disclaimers.				

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Table 7. Static characteristics 74HC4066 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V). V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input. V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
I _{CC}	supply current	$V_1 = V_{CC}$ or GND; $V_{is} = GND$ or V_{CC} ; $V_{os} = V_{CC}$ or GND				
		$V_{CC} = 6.0 V$	-	-	40	μΑ
		V _{CC} = 10.0 V	-	-	80	μΑ

[1] Typical values are measured at $T_{amb} = 25 \ ^{\circ}C$.

Table 8. Static characteristics 74HCT4066

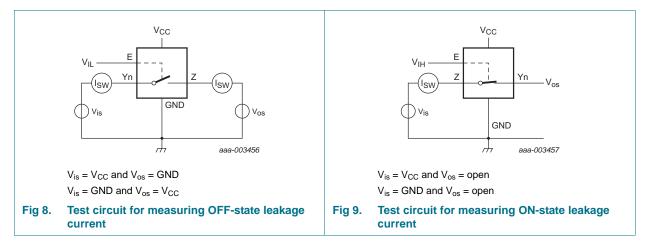
At recommended operating conditions; voltages are referenced to GND (ground = 0 V). V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input. V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
$T_{amb} = -40$	0 °C to +85 °C					
V _{IH}	HIGH-level input voltage	$V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$	2.0	1.6	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	1.2	0.8	V
l _l	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±1.0	μA
$I_{S(OFF)}$	OFF-state leakage current	V_{CC} = 5.5 V; V _I = V _{IH} or V _{IL} ; $ V_{SW} = V_{CC} - GND$; see Figure 8				
		per channel	-	-	±1.0	μA
I _{S(ON)}	ON-state leakage current	$V_{CC} = 5.5 \text{ V}; V_I = V_{IH} \text{ or } V_{IL};$ $ V_{SW} = V_{CC} - GND; \text{ see } Figure 9$	-	-	±1.0	μΑ
I _{CC}	supply current	$ V_{I} = V_{CC} \text{ or GND}; V_{is} = GND \text{ or } V_{CC}; $	-	-	20.0	μA
ΔI_{CC}	additional supply current	per input pin; V _I = V _{CC} – 2.1 V; other inputs at V _{CC} or GND; V _{CC} = 4.5 V to 5.5 V	-	100	450	μA
CI	input capacitance		-	3.5	-	pF
C _{sw}	switch capacitance		-	8	-	pF
$T_{amb} = -40$	0 °C to +125 °C					
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	-	-	V
V _{IL}	LOW-level input voltage	$V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$	-	-	0.8	V
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±1.0	μA
$I_{S(OFF)}$	OFF-state leakage current	$V_{CC} = 5.5 \text{ V}; V_I = V_{IH} \text{ or } V_{IL};$ $ V_{SW} = V_{CC} - GND; \text{ see } \frac{\text{Figure 8}}{1000}$				
		per channel	-	-	±1.0	μA
I _{S(ON)}	ON-state leakage current	$V_{CC} = 5.5 \text{ V}; V_I = V_{IH} \text{ or } V_{IL};$ $ V_{SW} = V_{CC} - GND; \text{ see } Figure 9$	-	-	±1.0	μΑ
I _{CC}	supply current	$ V_{I} = V_{CC} \text{ or GND; } V_{is} = \text{GND or } V_{CC}; $	-	-	40	μΑ
ΔI_{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1$ V; other inputs at V_{CC} or GND; $V_{CC} = 4.5$ V to 5.5 V	-	-	490	μΑ

[1] Typical values are measured at T_{amb} = 25 °C.

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10. Dynamic characteristics

Table 9. Dynamic characteristics 74HC4066

GND = 0 V; $t_r = t_f = 6 ns$; $C_L = 50 pF$ unless specified otherwise; for test circuit see <u>Figure 12</u>. V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input.

 V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions	–40 °C to +85 °C			–40 °C te	Unit		
				Min	Typ <mark>[1]</mark>	Max	Min	Мах	
t _{pd}	propagation delay	nY to nZ or nZ to nY; $R_L = \infty \Omega$; see <u>Figure 10</u>	[2]					1	
		$V_{CC} = 2.0 V$		-	8	75	-	90	ns
		$V_{CC} = 4.5 V$		-	3	15	-	18	ns
		$V_{CC} = 6.0 V$		-	2	13	-	15	ns
		$V_{CC} = 9.0 V$		-	2	10	-	12	ns
t _{off}	turn-off time	nE to nY or nZ; see Figure 11	<u>[4]</u>						
		$V_{CC} = 2.0 V$		-	44	190	-	225	ns
		$V_{CC} = 4.5 V$		-	16	38	-	45	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	13	-	-	-	ns
		$V_{CC} = 6.0 V$		-	13	33	-	38	ns
		$V_{CC} = 9.0 V$		-	16	26	-	30	ns
t _{on}	turn-on time	nE to nY or nZ; see Figure 11	[3]						
		$V_{CC} = 2.0 V$		-	36	125	-	150	ns
		$V_{CC} = 4.5 V$		-	13	25	-	30	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	11	-	-	-	ns
		$V_{CC} = 6.0 V$		-	10	21	-	26	ns
		$V_{CC} = 9.0 V$		-	8	16	-	20	ns
C _{PD}	power dissipation capacitance	per switch; $V_I = GND$ to V_{CC}	<u>[5]</u>	11		-	-	-	pF

[3] t_{on} is the same as t_{PHZ} and t_{PLZ} .

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[4] t_{off} is the same as $t_{PZH and} t_{PZL}$.

 C_{sw} = switch capacitance in pF;

 V_{CC} = supply voltage in V.

Table 10. Dynamic characteristics 74HCT4066

GND = 0 V; $t_r = t_f = 6 ns$; $C_L = 50 pF$ unless specified otherwise; for test circuit see Figure 12. V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input.

 V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions		–40 °C to +85 °C			–40 °C to +125 °C		Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _{pd}	propagation delay	nY to nZ or nZ to nY; $R_L = \infty \Omega$; see <u>Figure 10</u>	[2]						
		$V_{CC} = 4.5 V$		-	3	15	-	18	ns
t _{off} turn-of	turn-off time	nE to nY or nZ; see Figure 11	[4]						
		$V_{CC} = 4.5 V$		-	20	44	-	53	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	16	-	-	-	ns
t _{on} turn-on time	turn-on time	nE to nY or nZ; see Figure 11	[3]						
		$V_{CC} = 4.5 V$		-	12	30	-	36	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	12	-	-	-	ns
C_{PD}	power dissipation capacitance	per switch; $V_I = GND$ to ($V_{CC} - 1.5 V$)	<u>[5]</u>	-	12	-	-	-	pF

[1] Typical values are measured at $T_{amb} = 25 \ ^{\circ}C$.

[2] t_{pd} is the same as t_{PHL} and t_{PLH} .

[3] t_{on} is the same as t_{PHZ} and t_{PLZ} .

[4] t_{off} is the same as $t_{PZH and} t_{PZL}$.

[5] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $\mathsf{P}_{\mathsf{D}} = \mathsf{C}_{\mathsf{P}\mathsf{D}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}^2 \times \mathsf{f}_i + \sum \{(\mathsf{C}_{\mathsf{L}} + \mathsf{C}_{\mathsf{sw}}) \times \mathsf{V}_{\mathsf{C}\mathsf{C}}^2 \times \mathsf{f}_o\} \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz;

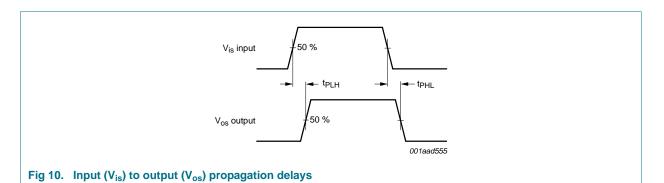
 $\sum \{(C_L + C_{sw}) \times V_{CC}^2 \times f_o\} = \text{sum of outputs};$

 C_L = output load capacitance in pF; C_{sw} = switch capacitance in pF;

 V_{CC} = supply voltage in V.

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11. Waveforms



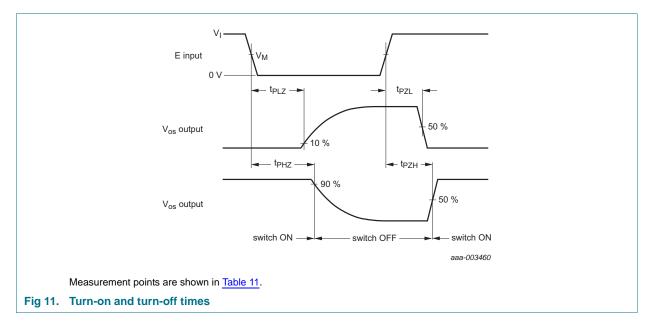


Table 11. Measurement points

Туре	VI	V _M
74HC4066	V _{CC}	0.5V _{CC}
74HCT4066	3.0 V	1.3 V

74HC4066; 74HCT4066

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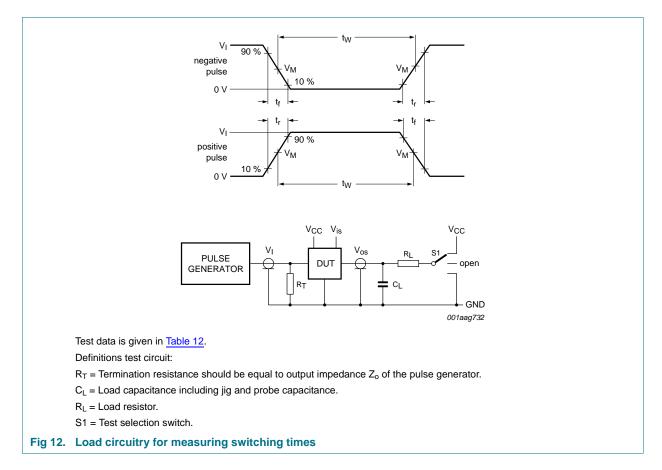


Table 12. Test data

Test	Input			Output		S1 position
	Control E	Switch Yn (Z)	t _r , t _f	Switch Z (Yn)		
	V <mark>[^[1]</mark>	V _{is}		CL	RL	_
t _{PHL} , t _{PLH}	GND	GND to V _{CC}	6 ns	50 pF	-	open
t _{PHZ} , t _{PZH}	GND to $V_{\mbox{\scriptsize CC}}$	V _{CC}	6 ns	50 pF, 15 pF	1 kΩ	GND
t _{PLZ} , t _{PZL}	GND to $V_{\mbox{\scriptsize CC}}$	GND	6 ns	50 pF, 15 pF	1 kΩ	V _{CC}

[1] For 74HCT4066: maximum input voltage $V_I = 3.0$ V.

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12. Additional dynamic characteristics

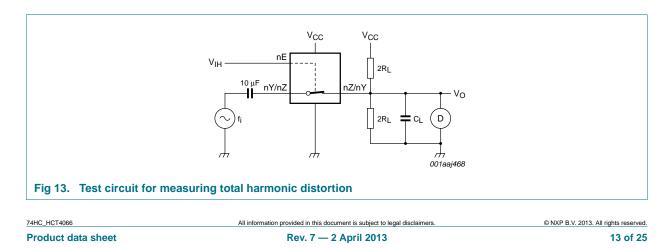
Table 13. Additional dynamic characteristics

Recommended conditions and typical values; GND = 0 V; $T_{amb} = 25 °C$. V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input. V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
THD	total harmonic distortion	$f_i = 1 \text{ kHz}; \text{ R}_L = 10 \text{ k}\Omega; \text{ C}_L = 50 \text{ pF};$ see Figure 13				%
		V _{CC} = 4.5 V; V _I = 4.0 V (p-p)	-	0.04	-	%
		V _{CC} = 9.0 V; V _I = 8.0 V (p-p)	-	0.02	-	%
		$f_i = 10 \text{ kHz}; \text{ R}_L = 10 \text{ k}\Omega; \text{ C}_L = 50 \text{ pF};$ see Figure 13				
		V _{CC} = 4.5 V; V _I = 4.0 V (p-p)	-	0.12	-	%
		V _{CC} = 9.0 V; V _I = 8.0 V (p-p)	-	0.06	-	%
f _(-3dB)	–3 dB frequency response	$R_L = 50 \Omega$; $C_L = 10 pF$; see <u>Figure 15</u>	[2]			
		V _{CC} = 4.5 V	-	180	-	MHz
		$V_{CC} = 9.0 V$	-	200	-	MHz
α_{iso}	isolation (OFF-state)	$R_L = 600 \ \Omega; C_L = 50 \ pF; f_i = 1 \ MHz;$ see Figure 14	[1]			
		V _{CC} = 4.5 V	-	-50	-	dB
		V _{CC} = 9.0 V	-	-50	-	dB
V _{ct}	crosstalk voltage	between digital input and switch (peak to peak value); $R_L = 600 \Omega$; $C_L = 50 pF$; $f_i = 1 MHz$; see <u>Figure 16</u>				
		$V_{CC} = 4.5 V$	-	110	-	mV
		V _{CC} = 9.0 V	-	220	-	mV
Xtalk	crosstalk	between switches; R _L = 600 Ω ; C _L = 50 pF; f _i = 1 MHz; see <u>Figure 17</u>	[1]			
		$V_{CC} = 4.5 V$	-	-60	-	dB
		$V_{CC} = 9.0 V$	-	-60	-	dB

[1] Adjust input voltage V_{is} to 0 dBm level (0 dBm = 1 mW into 600 Ω).

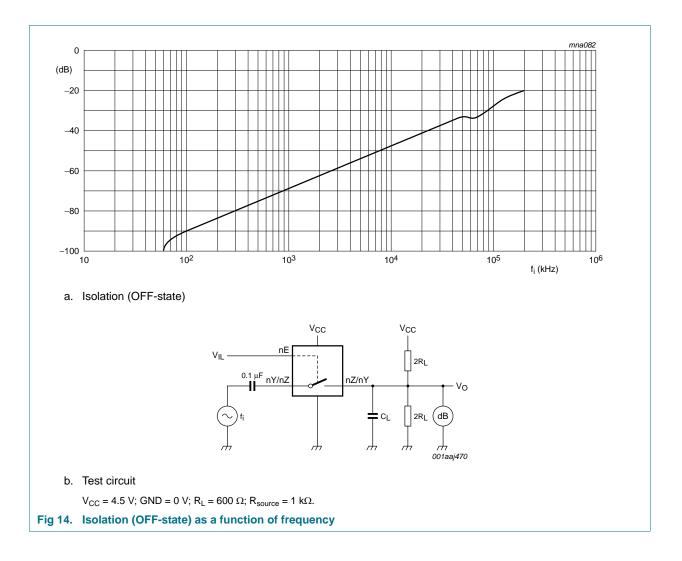
[2] Adjust input voltage V_{is} to 0 dBm level at V_{os} for $f_i = 1$ MHz (0 dBm = 1 mW into 50 Ω). After set-up, f_i is increased to obtain a reading of -3 dB at V_{os}.



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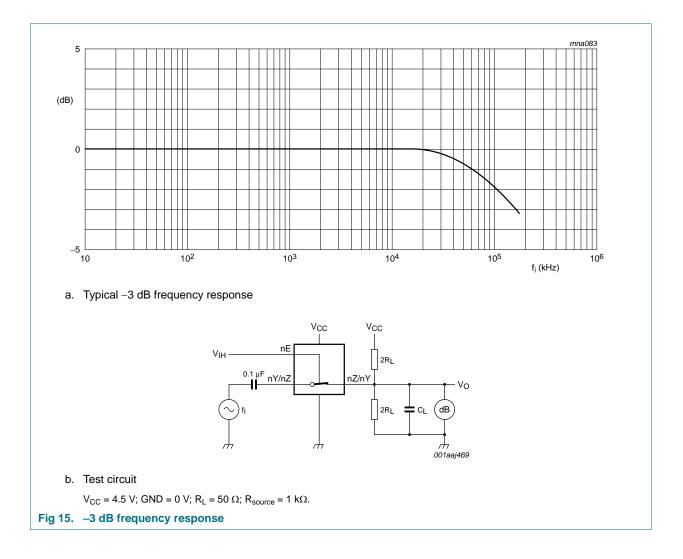
74HC4066; 74HCT4066

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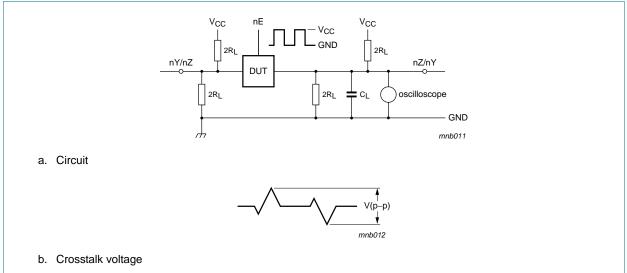
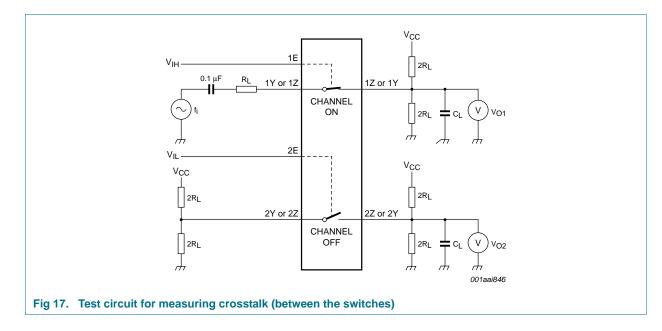


Fig 16. Test circuit for measuring crosstalk voltage (between the digital input and the switch)



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13. Package outline

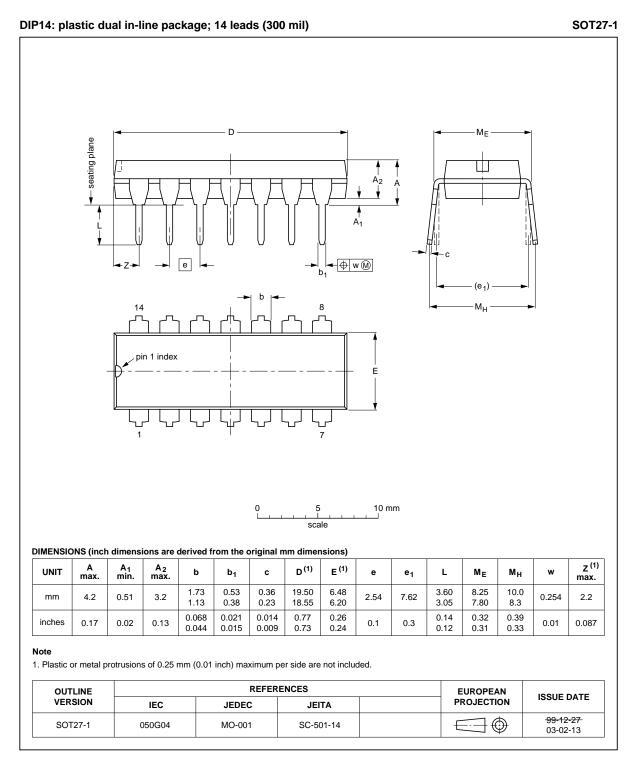


Fig 18. Package outline SOT27-1 (DIP14)

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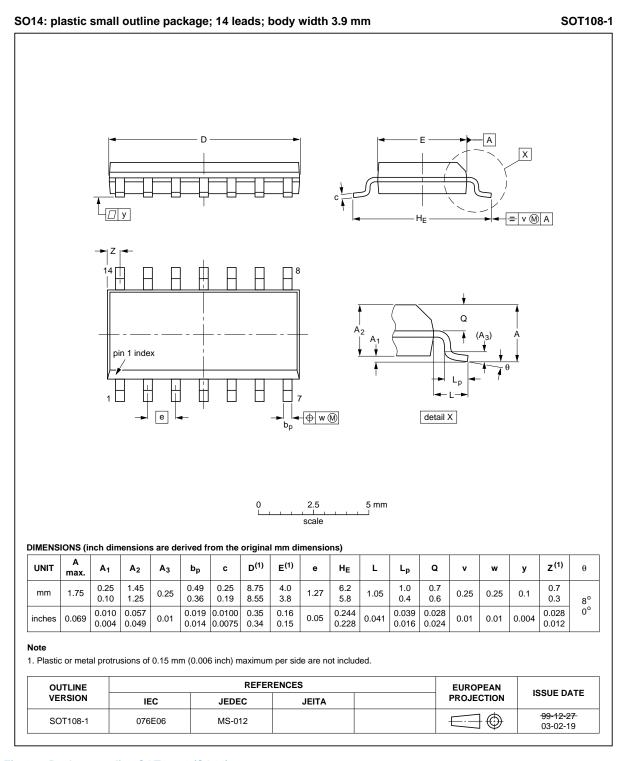


Fig 19. Package outline SOT108-1 (SO14)

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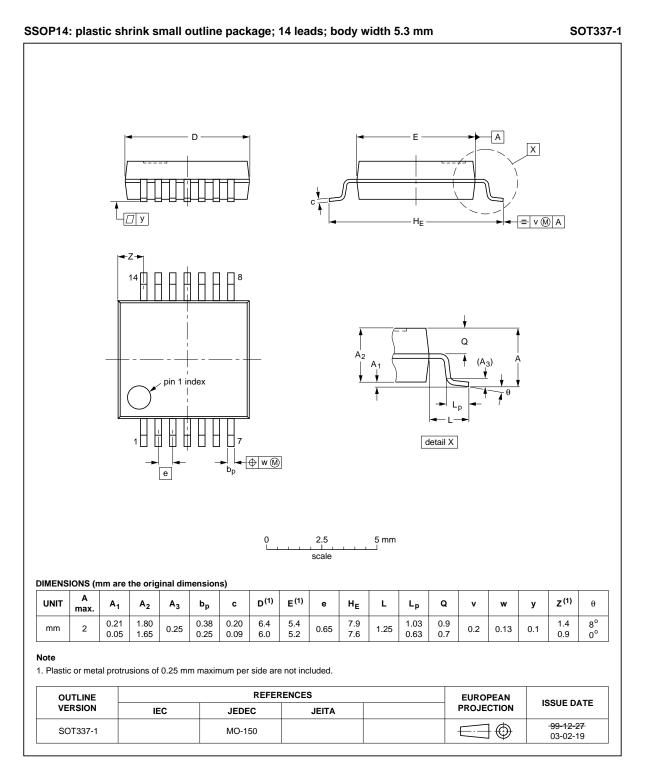


Fig 20. Package outline SOT337-1 (SSOP14)

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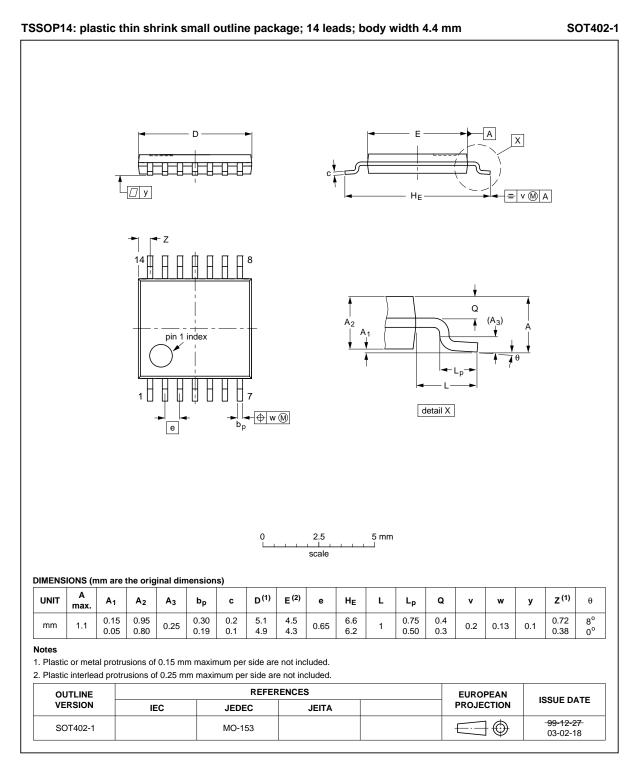


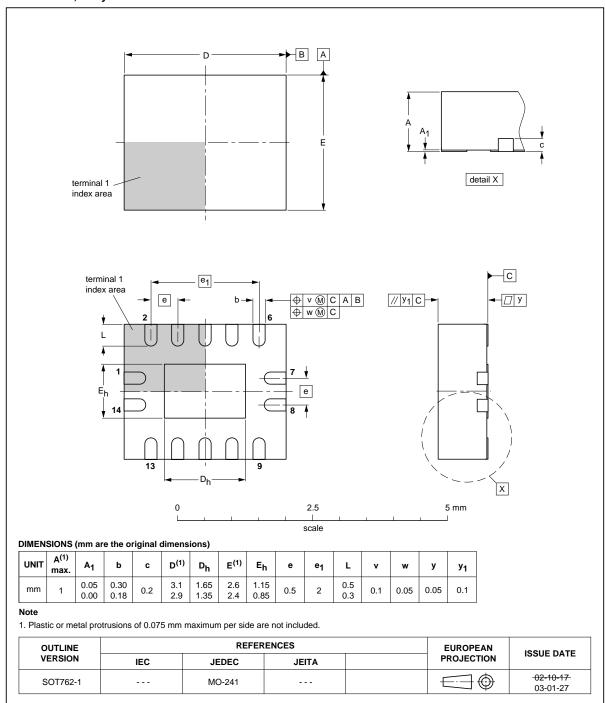
Fig 21. Package outline SOT402-1 (TSSOP14)

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DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

Fig 22. Package outline SOT762-1 (DHVQFN14)

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14. Abbreviations

Table 14. Abbreviations				
Acronym	Description			
CMOS	Complementary Metal Oxide Semiconductor			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
MM	Machine Model			

15. Revision history

Table 15. Revision histo	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT4066 v.7	20130402	Product data sheet	-	74HC_HCT4066 v.6
Modifications:	 Descriptive tit 	tle corrected (errata).		
	 New general 	description (errata).		
74HC_HCT4066 v.6	20120718	Product data sheet	-	74HC_HCT4066 v.5
Modifications:		f this data sheet has been rede NXP Semiconductors.	esigned to comply wi	th the new identity
	 Legal texts have 	ave been adapted to the new c	company name wher	e appropriate.
74HC_HCT4066 v.5	20041111	Product data sheet	-	74HC_HCT4066 v.4
74HC_HCT4066 v.4	20030617	Product data sheet	-	74HC_HCT4066_CNV v.3
74HC_HCT4067_CNV v.3	19981110	Product data sheet	-	74HC_HCT4066_CNV v.2
74HC_HCT4066_CNV v.2	19981002	Product specification	-	-

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16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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